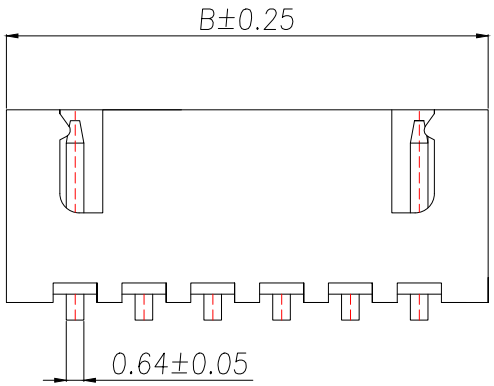
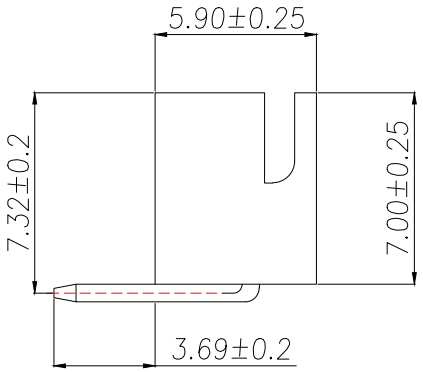
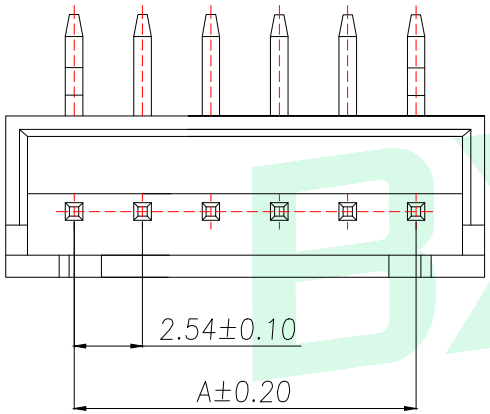
REV.	DESCRIPTION	ECN NO.	NAME	DATE







技术要求:

1.塑件材料:PA66(UL-94V-0)

2.接触件:黄铜镀锡

3.接触电阻:≤10mΩ

4.绝缘电阻:≥100MΩ

5.额定电压:250V AC DC

6.额定电流:2.0A AC DC

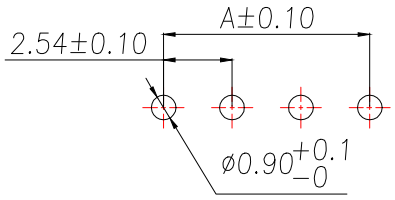
7.耐压:能承受1000V AC/Minute

8.工作温度:-25°~+85°

9.可焊性试验:浸锡面积≥95%温度235$^{+5°}_{-0°}$,时间2.5±0.5秒

10.铅和镉等六大有害物质含量要符合环保要求.

Part No	Pin	A	B
AF-XH2.54-2PWZ-W1	2	2.50	7.50
AF-XH2.54-3PWZ-W1	3	5.00	10.00
AF-XH2.54-4PWZ-W1	4	7.50	12.50
AF-XH2.54-5PWZ-W1	5	10.00	15.00
AF-XH2.54-6PWZ-W1	6	12.50	17.50
AF-XH2.54-7PWZ-W1	7	15.00	20.00
AF-XH2.54-8PWZ-W1	8	17.50	22.50
AF-XH2.54-9PWZ-W1	9	20.00	25.00
AF-XH2.54-10PWZ-W1	10	22.50	27.50
AF-XH2.54-11PWZ-W1	11	25.00	30.00
AF-XH2.54-12PWZ-W1	12	27.50	32.50
AF-XH2.54-13PWZ-W1	13	30.00	35.00
AF-XH2.54-14PWZ-W1	14	32.50	37.50
AF-XH2.54-15PWZ-W1	15	35.00	40.00
AF-XH2.54-16PWZ-W1	16	37.50	42.50
AF-XH2.54-17PWZ-W1	17	40.00	45.00
AF-XH2.54-18PWZ-W1	18	42.50	47.50
AF-XH2.54-19PWZ-W1	19	45.00	50.00
AF-XH2.54-20PWZ-W1	20	47.50	52.50



SUGGESTED PCB LAYOUT
(COMPONENT SIDE)

序号	名称	材料	数量	备注
2	端子Contact	黄铜	N*1	电镀(锡):整个表面镀底镍30u"MIN,再镀锡80u"MIN
1	基座Wafer	PA66 (UL94V-0)	1	白色

GENERAL TOLERANCE

DIM.	TOL.
.x	±0.20
.xx	±0.10
.xxx	±0.05
GENERAL ANGLE:	±2°

DONGGUAN BAOXUN PRECISION TECHNOLOGY CO., LTD

TITLE: WAFER XH2.54MM 弯针

DWG. NO.: AF-XH2.54-NPWZ-W1 | CHECKED: MAX

PART NO.: AF-XH2.54-NPWZ-W1 | DRAWN: ELLA

UNIT:	SCALE:	SHEET:	DWG. SIZE:	LAYER:	APPROVED:
mm	none	1of 1	A4	bxconn	WILL

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